

27.08.2007

PAGE: 1

REVISIO	N HISTORY:			
Revision	Date	Description	Written By	Approved By
1.0	09-May-2007	New Release.	XH	MH
2.0	21-May-2007	 Add "Number Of Colors" Add "Weight" In The Item 1.0. Modify "Outline Drawing". Modify "LOT NUMBERING SYSTEM" 	ХН	MH
3.0	27-Aug2007	 Modify ITEM 1.0 "GENERAL SPECIFICATION" Modify ITEM 3.0 "OUTLINE Drawing ". Modify ITEM 9.0 "BACKLIGHT SPECIFICATION" Modify ITEM 14.0 "PACKAGING STANDARD" 	XH	MH

CONTENTS

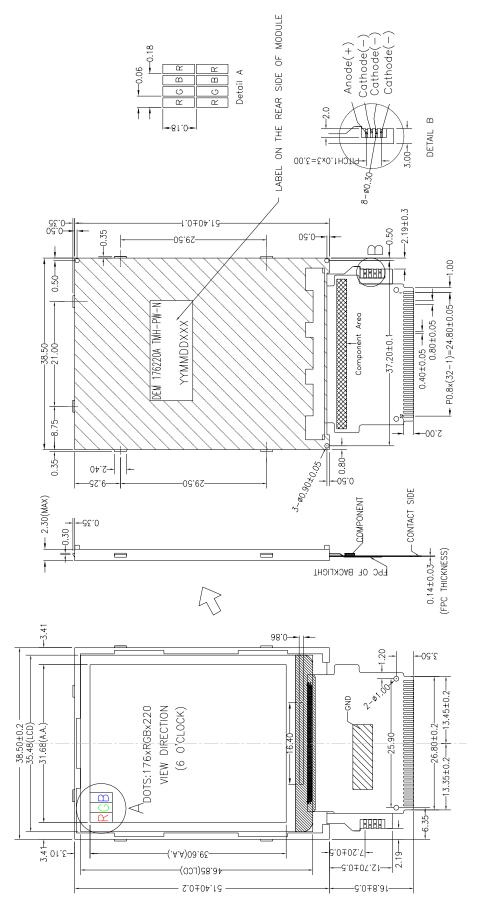
- **1.0 GENERAL SPECIFICATION**
- 2.0 OUTLINE DRAWING
- 3.0 INTERFACE PIN CONNECTION
- 4.0 BLOCK DIAGRAM
- 5.0 ABSOLUTE MAXIMUM RATIINGS
- 6.0 ELECTRICAL CHARACTERISTICS
- 7.0 OPTICAL CHARACTERISTICS
- 8.0 BACKLIGHT SPECIFICATION
- 9.0 STANDARD SPECIFICATION RELIABILITY
- **10.0 QUALITY ASSURANCE**
- **11.0 PRECAUTIONS FOR USING LCD MODUL**
- **12.0 LOT NUMBERING SYSTEM**
- **13.0 ROHS COMPLIANT PRODUCT**
- 14.0 LIMITED WARRANTY
- **15.0 APPENDIX: HX8340 INSTRUCTION SET**

1.0 GENERAL SPECIFICATION

ITEM	CONTENTS	UNIT
LCD Type	2.0 inch a-Si TFT-color transmissive	-
Module outer dimension	38.50 × 51.40 × 2.30	mm
Active display area	31.68 × 39.60	mm
Number of dots	176xRGBx 220	dots
Dot Pitch	0.06 × 0.18	mm
Pixel Pitch	0.18 × 0.18	mm
Color-filter-array	RGB-Stripe	-
Number Of Colors	262k	-
Viewing Direction	6	O'clock
Backlight	LED back-light / White / Lightguide / 50.000 hours	-
Drive IC	HX8340 (HIMAX)	-
	8080-system,	
MPU interface (*)	18/16/9/8-bit parallel bus	-
	Serial, RGB, VSYNC	
Operating temperature	$-20 \sim 70$	°C
Storage temperature	$-30 \sim 80$	°C
Weight	8	g

(*) Please refer to datasheet of TFT-driver

2.0 OUTLINE DRAWING

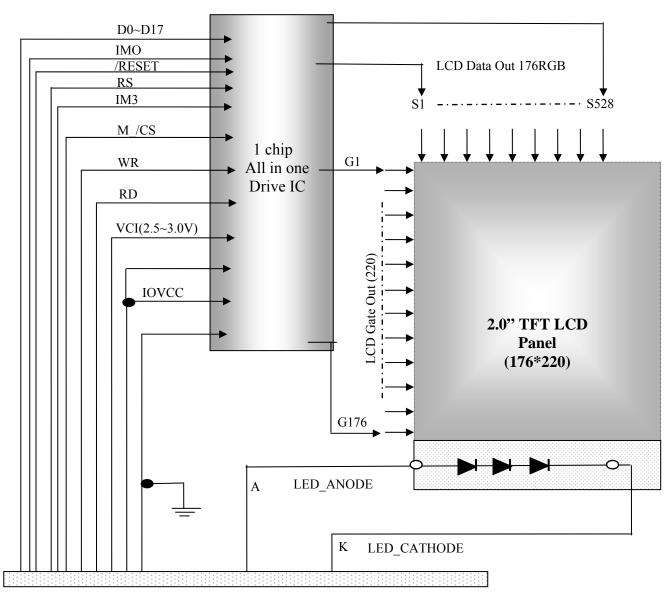


Version: 3.0

3.0 INTERFACE PIN CONNECTION

No	Port	Function	I/O
1	DUMMY	NC	-
2	GND	GROUND	Р
3	VCC	Power supply for the internal logic	Р
4	CS	Chip select, low active.	Ι
5	RS	Register select pin.	Ι
6	WR	Write enable pin.	Ι
7	RD	Read enable pin.	Ι
8	IM0	Select the MPU interface mode (please refer to HX8309 data sheet)	Ι
9	D0	Bi-directional data bus.	I/O
10	D1	Bi-directional data bus.	I/O
11	D2	Bi-directional data bus.	I/O
12	D3	Bi-directional data bus.	I/O
13	D4	Bi-directional data bus.	I/O
14	D5	Bi-directional data bus.	I/O
15	D6	Bi-directional data bus.	I/O
16	D7	Bi-directional data bus.	I/O
17	D8	Bi-directional data bus.	I/O
18	IM3	Select the MPU interface mode (please refer to HX8309 data sheet)	Ι
19	D9	Bi-directional data bus.	I/O
20	D10	Bi-directional data bus.	I/O
21	D11	Bi-directional data bus.	I/O
22	D12	Bi-directional data bus.	I/O
23	D13	Bi-directional data bus.	I/O
24	D14	Bi-directional data bus.	I/O
25	D15	Bi-directional data bus.	I/O
26	D16	Bi-directional data bus.	I/O
27	D17	Bi-directional data bus.	I/O
28	RESET	Reset pin, low active.	Ι
29	VCI	Analog power supply	Р
30	IOVCC	Power supply for the interface pins	Р
31	GND	GROUND	Р
32	DUMMY	NC	-

3.0 BLOCK DIAGRAM



4.0 ABSOLUTE MAXIMUM RATINGS (Ta = $25 \pm 2^{\circ}$ C, VSS=GND=0)

Item	Symbol	Value	Unit	Note
Power supply voltage(1)	IOVCC,VCC	-0.3 to +4.6	V	1, 2
Power supply voltage(2)	Vci ~ GND	-0.3 to +4.6	V	1, 2
Power supply voltage(3)	$VLCD \sim GND$	-0.3 to +6.0	V	3
Power supply voltage(4)	GND ~ VCL	-0.3 to +4.6	V	4
Power supply voltage(5)	$VLCD \sim VCL$	-0.3 to +9	V	5
Power supply voltage(6)	$VGH \sim GND$	-0.3 to +18.5	V	6
Power supply voltage(7)	$GND \sim VGL$	-0.3 to +18.5	V	7
Input Voltage	Vi	-0.3 to Vcc+0.3	V	-

Notes : 1. Vcc, VSSD must be maintained.

3. To make sure Vci \geq VSSA.

5. To make sure VLCD \geq VCL.

7. To make sure VSSA \geq VGL

2. To make sure IOVcc \geq VSSD.

4. To make sure VLCD \geq VSSA.

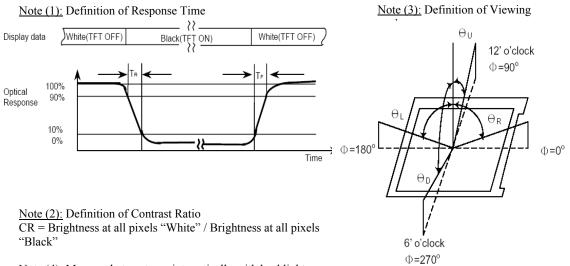
6. To make sure VGH \geq VSSA.

5.0 ELECTRICAL CHARACTERISTICS

Item	Symbol	Unit	Test condtion	Min.	Typ.	Max.	Note
Input high voltage	V _{IH}	V	IOVcc= 1.65 ~ 3.3V	0.8xIOVcc	-	IOVcc	-
Input low voltage	V _{IL}	V	IOVcc= 1.65 ~ 3.3V	-0.3V	-	0.2xIOVcc	-
Output high voltage (1) (DB0-17 Pins)	V _{OH1}	V	$I_{OH} = -0.1 \text{ mA}$	0.8xIOVcc	-	-	-
Output low voltage (DB0-17 Pins)	V _{OL1}	V	$IOVcc= 1.65 \sim$ 2.4V $I_{OL} = 0.1 mA$	-	-	0.2xIOVcc	-
I/O leakage current	I _{Li}	ūA	$Vin = 0 \sim Vcc$	-1	-	1	-
Current consumption during normal operation (Vcc – VSSD)+ (IOVcc- VSSD)	I _{OP} (Vcc)	ūA	Vci=IOVcc=Vcc=2.8 V, Ta=25°C, fOSC = 330KHz (220 Line) GRAM data = 0000h, Frame rate = 70Hz, REV=0, SAP=100,	-	150	300	-
Current consumption during normal operation (Vci – VSSD)	I _{OP} (Vci)	mA	AP=100, DC0=000, DC1=010,B/C=0, BT=001, VC=001, VRH=0011, VCM=10011,VDV= 10000, VCOMG=1, CL=0, No panel load		1.4	1.8	
Current consumption during standby mode (Vcc – VSSD) + (IOVcc-VSSD)	I _{ST(VCC)}	ūΑ	Vcc=2.8V, Ta=25C	-	1	10	-
Current consumption during standby mode (Vci – VSSD)	I _{ST(VCi)}	ūA			0.5	1	
Output voltage deviation	-	mV	-	-	5	-	-
Dispersion of the Average Output Voltage	V	mV	-	-	-	35	

7.0 OPTICAL CHARACTERISTICS

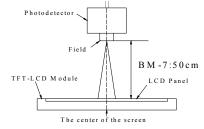
No	Item		Symbol	Condition	Min.	Тур.	Max.	Unit	Note		
1	Response Time	e	Tr	$\theta = \phi = 0_o$	-	15	30	ms	(1)		
			Tf		-	35	50				
2	Contrast Ratio		CR	$\theta = \phi = 0_o$	150	200	-	-	(2)		
3	Viewing Angle	;	Right	$\phi = 0_{\rm o}$	35	45	-	Deg	(3)		
	$(CR \ge 10)$		Left	$\phi = 180^{\circ}$	35	45	-	Deg			
			Upper	$\phi = 90^{\circ}$	30	35	-	Deg			
			Lower	$\phi = 270^{\circ}$	10	15	-	Deg			
4	Luminance of white(Center point)		L		200	250	-	Cd/m ²	(5)		
5	Color	Red	Rx	$\theta = \phi = 0^{\circ}$	0.610	0.640	0.670	-	(4)		
	Chromaticity		Ry		0.314	0.344	0.374	-			
	(CIE1931)	Green	Gx		0.268	0.298	0.328	-			
			Gy		0.553	0.583	0.613	-			
		Blue	Bx		0.102	0.132	0.162	-			
			By		0.107	0.137	0.167	-			
		White	Wx		0.282	0.312	0.342	-			
			Wy	Wy 0.319 0.349 0.379 -							
6	Optimum View Direction	ving	6 O'clock						-		



Note (4): Measured at center point vertically with backlight on.

Note(5):After stabilizing and leaving the panel alone at a given temperature for 30 min ,the measurement should be executed in a stable, windless, and dark room. 30 min after lighting the back-light. This should be measured in the center of screen.

Environment condition: Ta=25±2°C Back-Light On condition



Version: 3.0

8.0 BACKLIGHT SPECIFICATION

Item	Symbol	Min.	Тур.	Max.	Unit	Conditions	
Forward voltage	Vf	-	3.3	-	V	If = 45 mA	
Absolute Max. Forward Current	Ifm	45	-	70	mA	-	
Reverse current	Ir	-	-	15	mA	Vr = 3.0V	
Chromaticity	Х	0.270	-	0.315	-		
coordinates	Y	0.270	-	0.315	-		
Luminance (BLU only)	Lv	2800	3000	3200	cd/m ²	If = 40 mA	
Uniformity	Δ	80	85	-	%	Min/max*100%	
Remark	Patented LED						
Half-Brightness Life Time	50000 hours						

9.0 STANDARD SPECIFICAION FOR RELIABILITY

9.1 Standard specification of Reliability Test

No	Test Item	Content of Test	Test Condition	Applicable Standard						
1	High temperature storage	Endurance test applying the high storage temperature for a long time.	80+/-3 °C 240 hrs							
2	Low temperature storage	Endurance test applying the low storage temperature for a long time.	-30+/-3 °C 240 hrs							
3	High temperature operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70+/-3 °C 240 hrs							
4	Low temperature operation	Endurance test applying the electric stress under low temperature for a long time.	-20+/-3 °C 240 hrs							
5	High temperature / Humidity operation	Endurance test applying the electric stress (Voltage & Current) and temperature / humidity stress to the element for a long time.	40 °C , 90 %RH 120 hrs	MIL-202E- 103B JIS-C5023						
6	Temperature cycle	Endurance test applying the low and high temperature cycle. $\begin{array}{c} -20^{\circ}\text{C} \\ 30\text{min.} \end{array} \xrightarrow{25^{\circ}\text{C}} 5\text{min.} \end{array} \xrightarrow{70^{\circ}\text{C}} 30\text{min.} \\ 1 \text{ cycle} \end{array}$	-20°C / 70°C 10 cycles							
	Mechanical Test									
7	Drop Test	Endurance test applying the drop during transportation.	Packed, 100cm free fall (6 sides, 1 corner, 3edges)							

Remarks: For operation test, above specification is applicable when test pattern is changing during entire operation test. Please allow a 24hours recovery time for some display abnormality after reliability tests.

9.2 Failure Judgment Criteria

After the reliability tests above, test sample shall be let return to room temperature and humidity for at least 4 hours before final tests are carried out.

Criterion Item	Failure Judgment Criteria
Electrical characteristic	Electrical short and open.
Mechanical characteristic	Out of mechanical specification
Optical characteristic	Out of the Appearance Standard

10.0 QUALITY ASSURANCE

10.1 Acceptable Quality Level (AQL)

Each lot should satisfy the quality level defined as follows:

a) Inspection method: MIL-STD-105E Level II normal one time sampling

b) AQL level

Category	AQL	Definition
Major	0.25%	Functional defective as product
Minor	1.00%	Satisfy all functions as product but not satisfy cosmetic standard

10.2 Cosmetic Screening Criteria

No	Defect		Judgment Criteria							
1	Spots/Dust				Minor					
	/Bubble	Size, d (mm)	Acceptabl	e quantity in active area						
	(Round type)	d ≤ 0.15		Disregard						
		$0.15 < d \le 0.20$)	2						
		$0.2 \le d \le 0.30$		1						
		d > 0.3		0						
2	Dust				Minor					
	/Bubble /Scratches	Width, W (mm)	Length, L (mm)	Acceptable quantity in active area						
	(Line type)	₩≤ 0.01	W≤ 0.01 Disregard Disregard							
	(Line type)	₩≤ 0.03								
		₩≤ 0.05	₩≤ 0.05 L≤ 3.0 1							
		W> 0.05	Disregard	0						
3	Background	Not to be noticeab	le.		Minor					
	color &									
	Rainbow									
4	Allowable density	Above defects sho	ould be separated r	nore than 5mm each other.	Minor					
6	Coloration	Not to be noticeab	le coloration in th	e viewing area of the LCD	Minor					
		panels.		-						
		Back-lit type shou	ld be judged with	back-lit on state only.						
7	Rainbow	Not to be noticeab	Not to be noticeable.							
8	Dot size	To be 95% ~ 105%	% of the dot size (Typ.) in drawing.	Minor					
			· ·	nole) should be treated as						
		'spot'.	× 1	,						
	d = (long longth + gho	-			1					

Note: d = (long length + short length) / 2

11.0 PRECAUTIONS FOR USING LCD MODULE

Handing Precautions

- The display panel is made of glass and polarizer. Do not subject it to mechanical shock by dropping or impact which may cause chipping especially on the edges.
- Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully.
- If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with Isopropyl alcohol or ethyl alcohol. Avoid using solvents like acetone (ketene), water, toluene, ethanol to clean the polarizer surface.
- Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.
- Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary.
- Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion.
- Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.
- NC terminal should be open. Do not connect anything.
- If the logic circuit power is off, do not apply the input signals.
- Avoid contacting oil and fats.
- Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizers. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.
- Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading.

Electro-Static Discharge Control

- Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC.
- Be sure to ground the body when handling the LCD modules. Tools required for assembling, such as soldering irons, must be properly grounded.
- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions. To reduce the generation of static electricity, be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended.
- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated.
- When soldering the terminal of LCM, make certain the AC power source for the soldering iron does not leak.

Precaution for soldering to the LCM

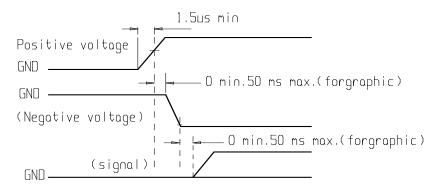
- Observe the following when soldering lead wire, connector cable and etc. to the LCD module.
- Soldering iron temperature: $300 \sim 350^{\circ}$ C.
 - Soldering time: 3 sec.
 - Solder: eutectic solder.

Above is a recommended approach. Due to different solder composition and processing method, it is recommended that customer to study and fine tuning their soldering process parameters accordingly.

- If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.

Precautions for Operation

- Viewing angle varies with the change of liquid crystal driving voltage (V_0). Adjust V_0 to show the best contrast.
- Driving the LCD in the voltage above the limit shortens its lifetime.
- Response time is greatly delayed at temperature below the operating temperature range. However, it will recover when it returns to the specified temperature range.
- If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.
- When turning the power on, input each signal after the positive/negative voltage becomes stable



Storage

- When storing LCDs as spares for some years, the following precautions are necessary.
- Store them in a sealed polyethylene bag. If properly sealed, there is no need for desiccant.
- Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C.
- Environmental conditions:
- Do not leave them for more than 168hrs. at 60°C.
- Should not be left for more than 48hrs. at -20°C.

Safety

- It is recommended to crush damaged or unnecessary LCD into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.
- If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

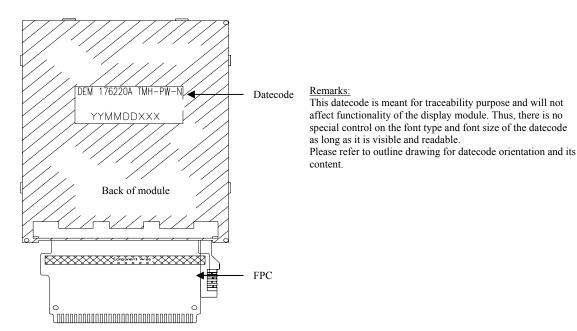
12.0 LOT NUMBERING SYSTEM

12.1 One lot means the delivery date and times to customer at one time.

$\underline{\mathbf{YYMMDD}}_{(1)} \underline{\mathbf{XXX}}_{(2)}$

- (1) Manufacturing date (COG bonding) (YY: Year, MM: Month, DD: Day)
- (2) Serial number starts from A01, A02....,A99, B01, B02....

12.2 Location of lot number



13.0 RoHS COMPLIANT PRODUCT

Standard of specific chemical substance

- 1. Cadmium and Cadmium Compounds
- 2. Hexavalent Chromium Compounds
- 3. Lead and Lead Compounds
- 4. Mercury and Mercury Compounds
- 5. Polybrominated Biphenyls (PBBs)
- 6. Polybrominated Diphenyl ethers (PBDEs)

14.0 LIMITED WARRANTY

Unless agreed between DISPLAY and customer, DISPLAY will replace or repair any of its LCD modules, which are found to be functionally defective when inspected in accordance with DISPLAY LCD acceptance standards (copies available upon request) for a period of one year from date of shipments. Cosmetic/visual defects must be returned to DISPLAY within 90 days of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of DISPLAY limited to repair and/or replacement on the terms set forth above. DISPLAY will not be responsible for any subsequent or consequential events.

Less than 100ppm Less than 1000ppm Less than 1000ppm Less than 1000ppm Less than 1000ppm Less than 1000ppm

15. APPENDIX: HX8340 Instruction Sets

(Please also refer to datasheet)

Register	Register	R/W	De				Upper	Code	2	e.	24		20		Low	er C ode			2	Instruction
No.		W	0	RB15 *	RB14 *	RB13	RB12	RB11 *	RB10 *	RB9 *	RB8	RB7 *	RB6 ID6	RB5 ID5	RB4 ID4	RB3 ID3	RB2 ID2	RB1 ID1	RB0 ID0	Insudenti
IR	Index	R	0		L6	L5	L4	L3	L2	L1	LO	0	0	0	0	0	0		0	
SR	Status Read Oscillation Start	W	1	*	*	*	*	*	*	*	*	*	*	*	*	*	*	*	1	
ROOh	Device Code Read	R	1	1	0	0	0	0	0	1	1	0	0	0	0	1	0	0	1	
R01h	Driver Output Control	w	1	0	VSPL	HSPL	DPL	EPL	SM	GS	SS	0	0	0	NL4	NL3	NL2	NL1	NLO	
R02h		w	1	0	(0)	(0)	(0) 0	(0) FLD	(0) FLD0	(0) B/C	(0) EOR	0	0	NW5	(1) NW4	(1) NW3	(1) NW2	(0) NW1	(1) NW0	
	LCD AC driving Control			TRI	DFM1	DFM0	BGR	(0)	(1)	(0)	(0)			(0) I/D1	(0) 1/D0	(0) AM	(0) LG2	(0) LG1	(0) LG0	-
R03h	Entry Mode	W	1	(0)	(0)	(0)	(0)	0	0	0	0	0	0	(1)	(1)	(0)	(0)	(0)	(0)	
R04h	Compare Register (1)	W	1	0	0	CP11 (0)	CP10 (0)	CP9 (0)	CP8 (0)	CP7 (0)	CP6 (0)	0	0	CP5 (0)	CP4 (0)	CP3 (0)	CP2 (0)	CP1 (0)	CP0 (0)	
R05h	Compare Register (2)	w	1	0	0	0	0	0	O	0	0	0	0	CP17 (0)	CP16 (0)	CP15 (0)	CP14 (0)	CP13 (0)	CP12 (0)	
R07h	Display Control (1)	w	1	0	0	0	PT1 (0)	PTO (0)	VLE2 (0)	VLE1 (0)	SPT (0)	0	0	GON (0)	DTE (0)	CL (0)	REV (0)	D1 (0)	D0 (0)	
R08h	Display Control (2)	w	1	0	0	0	0	FP3 (1)	FP2 (0)	FP1 (0)	FP0 (0)	O	0	0	0	BP3 (1)	BP2 (0)	BP1 (0)	BP0 (0)	
R09h	Display Control (3)	w	1	0	0	0	0	0	0	0	0	0	0	PTG1 (0)	PTG0 (0)	ISC3 (0)	ISC2 (0)	ISC1 (0)	ISC0 (0)	
ROBh	Frame Cycle	w	1	GD1	GD0 (0)	SDT1 (0)	SDT0	CE1	CEO	DIV 1	DIVO	0	0	0	0	RTN3 (0)	RTN2	RTN1 (0)	RTN0 (0)	
ROCh	Adjustment Control External Display	w	1	(0)	0	0	(0)	(0) 0	(0)	(0)	(0) RM	0	0	DM1	DM0	0	(0) 0	RIM1	RIMO	
R10h	Interface Control Power Control (1)	w	1	0	SAP2	SAP1	SAPO	0	BT2	BT1	(0) BT0	0	AP2	(0) AP1	(0) AP0	0	DK	(0) SLP	(0) STB	
i i i i					(0)	(0)	(0)		(0) DC12	(0) DC11	(0) DC10	-	(0) DC02	(0) DC01	(0) DC00		(1) VC2	(0) VC1	(0) V C0	
R11h	Power Control (2)	W	1	0	0	0	0	0	(0)	(0)	(0)	0	(0)	(0)	(0)	0	(0)	(0)	(0)	
R12h	Power Control (3)	W	1	0	0	0	0	0	0	0	0	0	0	0	PON (0)	VRH3 (0)	VRH2 (0)	VRH1 (0)	VRH0 (0)	
R13H	Power Control (4)	W	1	0	0	VCOMG (0)	VDV4 (0)	VDV3 (0)	VDV2 (0)	VDV1 (0)	V D V O (0)	0	0	0	VCM4 (0)	V CM3 (0)	VCM2 (0)	V CM1 (0)	V CM0 (0)	
R21h	RAM Address Set	W	1	AD15 (0)	AD14 (0)	AD13 (0)	AD12 (0)	AD11 (0)	AD10 (0)	AD9 (0)	AD8 (0)	AD7 (0)	AD6 (0)	AD5 (0)	AD4 (0)	AD3 (0)	AD2 (0)	AD1 (0)	AD0 (0)	
R22h	RAM data Write/Read	W	1			A. Constant of the			RAM		No.	17-0/R.	AM		RD17-0)					
R23h	RAM Write Data Mask (W	1	0	0	WM11 (0)	WM10 (0)	WM9 (0)	WM8 (0)	WM7 (0)	WM6 (0)	0	0	WM3 (0)	WM4 (0)	WM3 (0)	WM2 (0)	WM1 (0)	WM0 (0)	
R24h	RAM Write Data Mask (.	w	1	0	0	0	0	0	0	0	0	0	0	WM17 (0)	WM16 (0)	WM15 (0)	WM14 (0)	WM13 (0)	WM12 (0)	
R30h	r Control (1)	w	1	0	0	0	0	0	MP12 (0)	MP11 (0)	MP10 (0)	0	0	0	0	0	MP02 (0)	MP01 (0)	MP00 (0)	
R31h	r Control (2)	w	1	0	0	0	0	0	MP32 (0)	MP31 (0)	MP30 (0)	0	0	0	0	0	MP22 (0)	MP21 (0)	MP20 (0)	
R32h	r Control (3)	w	1	0	0	0	0	0	MP52 (0)	MP 51 (0)	MP50 (0)	0	0	0	0	0	MP 42 (0)	MP41 (0)	MP40 (0)	
R33h	r Control (4)	w	1	0	0	0	0	0	CP12 (0)	CP11 (0)	CP10 (0)	0	0	0	0	0	CP02 (0)	CP01	CP00	
R34h	r Control (5)	w	1	0	0	0	0	0	MN12	MN11	MN10	0	0	0	0	0	MN02	(0) MN01	(0) MN00	
R35h	r Control (6)	w	1	0	0	0	0	0	(0) MN32	(0) MN31	(0) MN 30	0	0	0	0	0	(0) MN22	(0) MN21	(0) MN20	
R36h	r Control (7)	w	1	0	0	0	0	0	(0) MN52	(0) MN51	(0) MN 50	0	0	0	0	0	(0) MN42	(0) MN41	(0) MN40	-
R37h	r Control (8)	w	1	0	0	0	0	0	(0) CN12	(0) CN11	(0) CN 10	0	0	0	0	0	(0) CN02	(0) CN01	(0) CN00	-
in the	The second		-	10			OP14	OP13	(0) OP12	(0) OP11	(0) OP10			•	•	OP03	(0) OP02	(0) OP01	(0) OP00	-
R38h	r Control (9)	W	1	0	0	0	(0) ON14	(0) ON13	(0) ON12	(0) ON11	(0) ON 10					(0) ON03	(0) ON02	(0) ON01	(0) ON00	-
R39h	r Control (10)	W	1	0	0	0	(0)	(0)	(0)	(0)	(0)					(0)	(0)	(0)	(0)	
R40h	G ate Skan Start Position	W	1	0	0	0	0	0	0	0	0	0	0	0	SCN4 (0)	SCN3 (0)	SCN2 (0)	SCN1 (0)	SCN0 (0)	
R41h	Vertical Scroll Control	w	1	0	0	0	0	0	0	0	0	VL7 (0)	VL6 (0)	VL5 (0)	VL4 (0)	VL3 (0)	VL2 (0)	VL1 (0)	VL0 (0)	
R42h	First Screen Driving Position	w	1	SE17 (1)	SE16 (1)	SE15 (0)	SE14 (1)	SE13 (1)	SE12 (0)	SE11 (1)	SE10 (1)	SS17 (0)	SS17 (0)	SS17 (0)	SS17 (0)	SS17 (0)	SS17 (0)	SS17 (0)	SS17 (0)	
R43h	Second Screen Driving Position	w	1	SE27 (1)	SE26 (1)	SE25 (0)	SE24 (1)	SE23 (1)	SE22 (0)	SE21 (1)	SE20 (1)	SS27 (0)	SS26 (0)	SS25 (0)	SS24 (0)	SS23 (0)	SS22 (0)	SS21 (0)	SS20 (0)	
R44h	Horizontal RAM	w	1	HEA7	HEA6	HEA5	HEA4	HEA3	HEA2	HEA1	HEAD	HSA7	HSA6	HSA5	HSA4	HSA3	HSA2	HSA1	HSAO	
an a	Address Position Vertical RAM	anasi.	1	(1) VEA7	(0) V E A6	(1) VEA5	(0) VEA4	(1) VEA3	(1) VEA2	(1) VEA1	(1) VEA0	(0) V SA7	(0) ∀SA6	(0) VSA5	(0) VSA4	(0) VSA3	(0) ▼SA2	(0) VSA1	(0) VSA0	
R45h	Address Position	W	1	(1)	(1)	(0)	(1)	(1)	(0)	(1)	(1)	(0)	(0)	(0)	(0)	(0)	(0)	(0)	(0)	